

T-1 3/4 (5mm) BLINKING LED LAMP

Features

- 5mm package with built-in blinking IC
- Blinking frequency: 3.0Hz to 1.5Hz
- Operation voltage: 3.5V to 14V
- RoHS compliant.

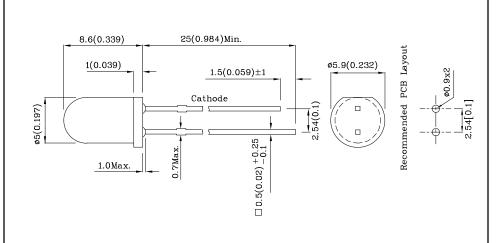






ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Green (GaP)	Unit		
Reverse Voltage	$V_{\rm R}$	0.5	V		
Forward Voltage	V_{F}	14	V		
Power Dissipation	P_D	310	mW		
Operating Temperature	T _A -40 ~ +70		°C		
Storage Temperature	Tstg	-40 ~ +85			
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds				

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Green (GaP)	Unit
Forward Current (Min.) (V _F =3.5V)	I_{F}	8	mA
Forward Current (Typ.) (V _F =5V)	I_{F}	22	mA
Supply Current (Typ.) (V _F =3.5V)	I_{SON}	8	mA
Supply Current (Typ.) (V _F =14V)	I_{SON}	44	mA
Blink Frequency (Min.~Max.) (V _F =3.5V~14V)	f	1.5~3	Hz
Wavelength of Peak Emission CIE127-2007* (Typ.)	λΡ	565*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.)	λD	568*	nm
Spectral Line Full Width At Half- Maximum (Typ.)	Δλ	30	nm

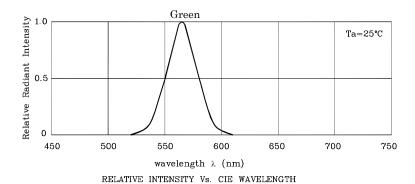
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(V}_{\text{F}}\text{=}9\text{V)} \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XBUG53D	Green	GaP	Green Diffused	15*	29*	565*	60°

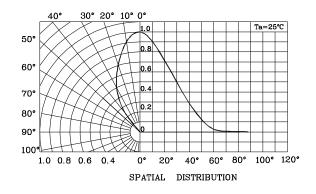
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

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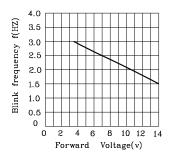


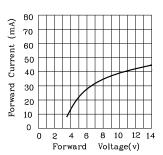




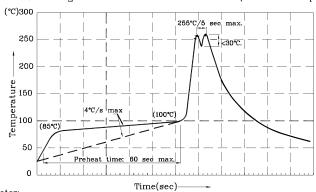


❖ Green





Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



Notes:

- Rotes:
 1.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
 2.Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.

 4.Fixtures should not incur stress on the component when mounting and during soldering process.

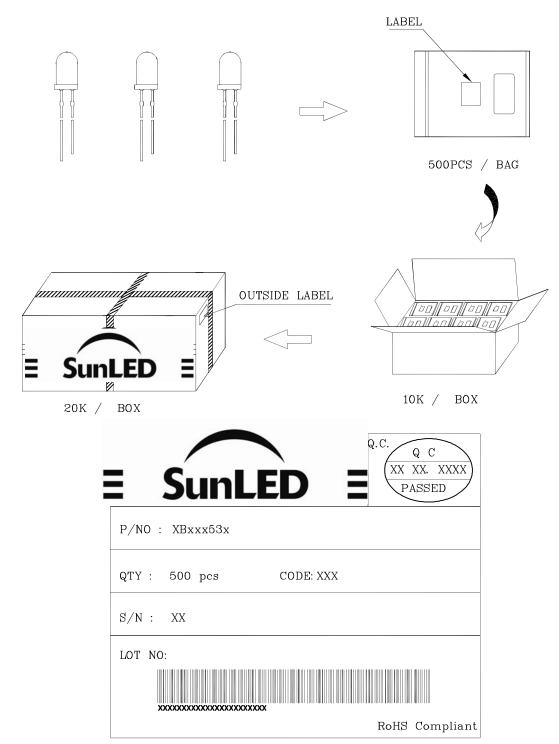
 5.SAC 305 solder alloy is recommended.

 6.No more than one wave soldering pass.





PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- $2. \ Contents \ within \ this \ document \ are \ subject \ to \ improvement \ and \ enhancement \ changes \ without \ notice.$
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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